# **74ALVC00**

# Quad 2-input NAND gate Rev. 3 — 16 May 2014

Product data sheet

#### 1. **General description**

The 74ALVC00 is a quad 2-input NAND gate.

Schmitt trigger action on all inputs makes the device tolerant of slow rise and fall times.

#### 2. **Features and benefits**

- Wide supply voltage range from 1.65 V to 3.6 V
- 3.6 V tolerant inputs/outputs
- CMOS low power consumption
- Direct interface with TTL levels (2.7 V to 3.6 V)
- Power-down mode
- Latch-up performance exceeds 250 mA
- Complies with JEDEC standards:
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - ◆ JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114E exceeds 2000 V
  - ♦ MM JESD22-A115-A exceeds 200 V

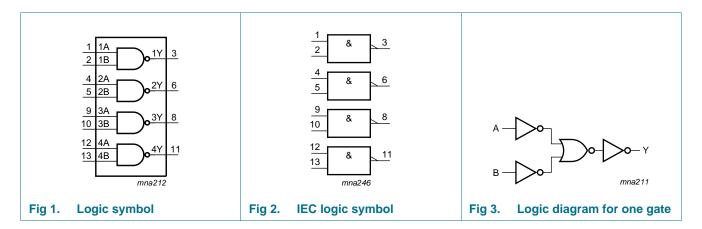
#### **Ordering information** 3.

Table 1. **Ordering information** 

Type number	Package								
	Temperature range	Name	Description	Version					
74ALVC00D	–40 °C to +85 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1					
74ALVC00PW	–40 °C to +85 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1					
74ALVC00BQ	-40 °C to +85 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1					

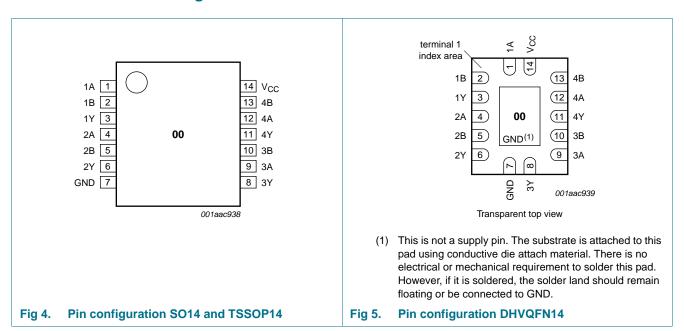


# 4. Functional diagram



### 5. Pinning information

#### 5.1 Pinning



#### 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1A to 4A	1, 4, 9, 12	data input
1B to 4B	2, 5, 10, 13	data input
1Y to 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V <sub>CC</sub>	14	supply voltage

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**Quad 2-input NAND gate** 

# 6. Functional description

Table 3. Function selection[1]

Input		Output
nA	nB	nY
L	X	Н
X	L	Н
Н	Н	L

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level; X = don't care

# 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-50	-	mA
V <sub>I</sub>	input voltage			-0.5	+4.6	V
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0 \text{ V}$		-	±50	mA
Vo	output voltage	output HIGH or LOW state	[1] [2]	-0.5	V <sub>CC</sub> + 0.5	V
		output 3-state		-0.5	+4.6	V
		power-down mode, $V_{CC} = 0 \text{ V}$	[2]	-0.5	+4.6	V
Io	output current	$V_O = 0 V to V_{CC}$		-	±50	mA
I <sub>CC</sub>	supply current			-	100	mA
I <sub>GND</sub>	ground current			-100	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	[3]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For DHVQFN14 packages: above 60 °C derate linearly with 4.5 mW/K.

<sup>[2]</sup> When  $V_{CC} = 0 \text{ V}$  (power-down mode), the output voltage can be 3.6 V in normal operation.

<sup>[3]</sup> For SO14 packages: above 70 °C derate linearly with 8 mW/K. For TSSOP14 packages: above 60 °C derate linearly with 5.5 mW/K.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	output HIGH or LOW state	0	$V_{CC}$	V
		output 3-state	0	3.6	V
		power-down mode; $V_{CC} = 0 \text{ V}$	0	3.6	V
T <sub>amb</sub>	ambient temperature	in free air	-40	+85	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 1.65 V to 2.7 V	0	20	ns/V
		V <sub>CC</sub> = 2.7 V to 3.6 V	0	10	ns/V

### 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> =	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +85  ^{\circ}\text{C}$					
			Min	Typ[1]	Max				
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V			
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	V			
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	V			
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V			
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V			
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	V			
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$							
		$I_{O} = -100 \mu A$ ; $V_{CC} = 1.65 V$ to 3.6 V	V <sub>CC</sub> - 0.2	-	-	V			
		$I_{O} = -6 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.25	1.51	-	V			
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	2.10	-	V			
		$I_{O} = -18 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.7	2.01	-	V			
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	2.53	-	V			
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	2.76	-	V			
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	2.68	-	V			
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$							
		$I_{O}$ = 100 $\mu$ A; $V_{CC}$ = 1.65 V to 3.6 V	-	-	0.2	V			
		I <sub>O</sub> = 6 mA; V <sub>CC</sub> = 1.65 V	-	0.11	0.3	V			
		$I_{O}$ = 12 mA; $V_{CC}$ = 2.3 V	-	0.17	0.4	V			
		$I_{O}$ = 18 mA; $V_{CC}$ = 2.3 V	-	0.25	0.6	V			
		$I_{O}$ = 12 mA; $V_{CC}$ = 2.7 V	-	0.16	0.4	V			
		$I_O = 18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.23	0.4	V			
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.30	0.55	V			
l <sub>l</sub>	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 3.6 \text{ V or GND}$	-	±0.1	±5	μΑ			
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V}$	-	±0.1	±10	μΑ			

**Quad 2-input NAND gate** 

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> =	Unit		
			Min	Typ[1]	Max	
I <sub>CC</sub>	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.2	20	μΑ
$\Delta I_{CC}$	additional supply current	per input pin; $V_{CC} = 3.0 \text{ V}$ to 3.6 V; $V_{I} = V_{CC} - 0.6 \text{ V}$ ; $I_{O} = 0 \text{ A}$	-	5	750	μΑ
Cı	input capacitance		-	3.5	-	pF

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V (unless stated otherwise) and  $T_{amb}$  = 25 °C.

# 10. Dynamic characteristics

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit, see Figure 7.

Symbol	Parameter	Conditions	T <sub>amb</sub> =	Unit			
				Min	Typ[1]	Max	
t <sub>pd</sub>	propagation delay	nA, nB to nY; see Figure 6	[2]				
		V <sub>CC</sub> = 1.65 V to 1.95 V		1.0	2.8	4.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.0	2.1	2.8	ns
		V <sub>CC</sub> = 2.7 V		1.0	2.6	3.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	V <sub>CC</sub> = 3.0 V to 3.6 V		2.1	3.0	ns
C <sub>PD</sub>	power dissipation capacitance	per gate; $V_I = GND$ to $V_{CC}$ ; $V_{CC} = 3.3 \text{ V}$	[3]	-	28	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where:

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs

<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .

<sup>[3]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

# 11. Waveforms

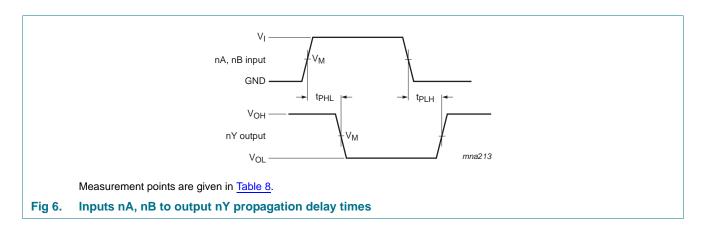
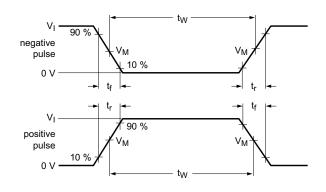


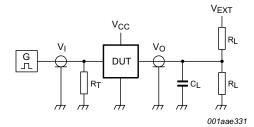
Table 8. Measurement points

Supply voltage V <sub>CC</sub>	Input V <sub>I</sub>	V <sub>M</sub>
1.65 V to 1.95 V	V <sub>CC</sub>	0.5V <sub>CC</sub>
2.3 V to 2.7 V	V <sub>CC</sub>	0.5V <sub>CC</sub>
2.7 V	2.7 V	1.5 V
3.0 V to 3.6 V	2.7 V	1.5 V

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**Quad 2-input NAND gate** 





Test data is given in Table 9.

Definitions for test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

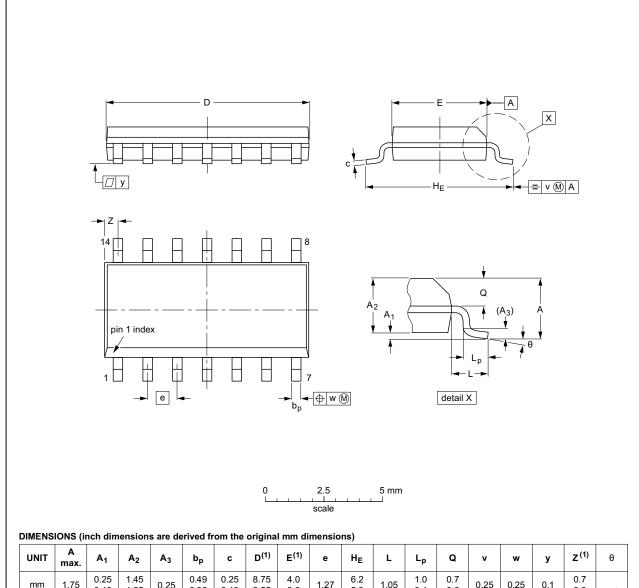
Table 9. Test data

Supply voltage V <sub>CC</sub>	Input		Load		V <sub>EXT</sub>	V <sub>EXT</sub>		
	$V_{l}$ $t_{r}, t_{f}$		CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	
1.65 V to 1.95 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	6 V	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	6 V	GND	

# 12. Package outline

#### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



UNI	Γ A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inche	es 0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

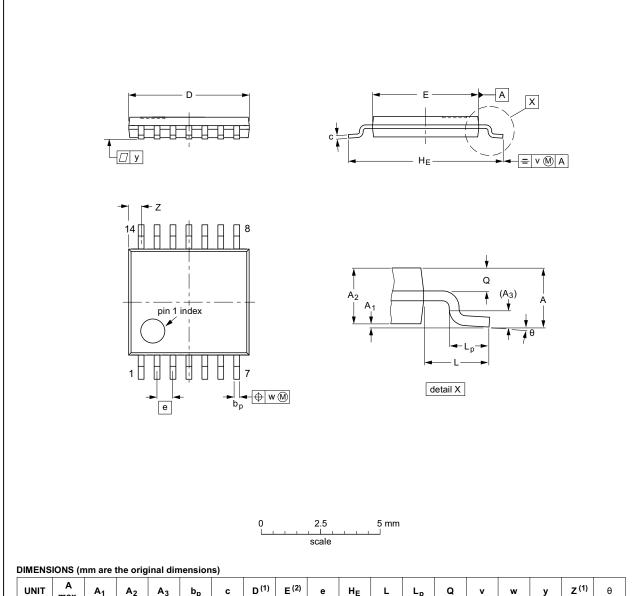
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012				<del>99-12-27</del> 03-02-19

Package outline SOT108-1 (SO14) Fig 8.

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bp	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	٧	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT402-1		MO-153				<del>-99-12-27</del> 03-02-18	
SOT402-1		MO-153				<u>ታ</u>	<b>1</b> 4

Fig 9. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

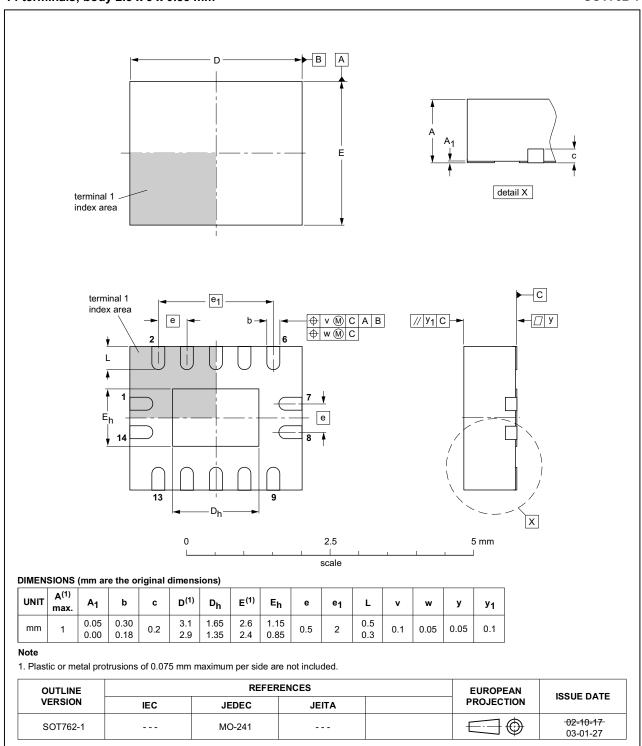


Fig 10. Package outline SOT762-1 (DHVQFN14)

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# 13. Abbreviations

#### Table 10. Abbreviations

Acronym	Description	
CDM	Charged Device Model	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
НВМ	Human Body Model	
MM	Machine Model	
TTL	Transistor-Transistor Logic	

# 14. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
74ALVC00 v.3	20140516	Product data sheet	-	74ALVC00 v.2				
	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>							
	<ul> <li>Legal texts have be</li> </ul>	en adapted to the new co	mpany name where app	ropriate.				
74ALVC00 v.2	20030514	Product specification	-	74ALVC00 v.1				
74ALVC00 v.1	20030206	Product specification	-	-				

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#### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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